

1200V, 25A, Trench NPT IGBT

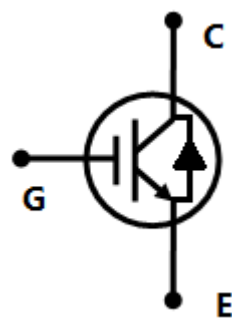
Features

- Trench NPT(Non Punch Through) IGBT
- High speed switching
- Low saturation voltage: $V_{CE(sat)}=2.0V@I_C=25A$
- High input impedance



Applications

- Inductive heating, Microwave oven, Inverter, UPS, etc.
- Soft switching applications



Absolute Maximum Ratings

Symbol	Description	Ratings	Units
V_{CES}	Collector to Emitter Voltage	1200	V
V_{GES}	Gate to Emitter Voltage	+/-30	V
I_C	Continuous Collector Current @ $T_C=25^{\circ}C$	50	A
	Continuous Collector Current @ $T_C=100^{\circ}C$	25	A
$I_{CM}(1)$	Pulsed Collector Current	90	A
I_F	Diode Continuous Forward Current @ $T_C=100^{\circ}C$	25	
I_{FM}	Diode Maximum Forward Current	150	A
P_D	Maximum Power Dissipation @ $T_C=25^{\circ}C$	312	W
	Maximum Power Dissipation @ $T_C=100^{\circ}C$	125	W
T_J	Operating Junction Temperature	-55 to +150	$^{\circ}C$
T_{stg}	Storage Temperature Range	-55 to +150	$^{\circ}C$
T_L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5seconds	300	$^{\circ}C$

Notes:

1. Repetitive rating, Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\square JC}$	Thermal Resistance, Junction to Case	-	0.4	°C/W
R_{JA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

Electrical Characteristics of the IGBT $T_C=25^\circ\text{C}$

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} =0V, I _c =1mA	1200	-	-	V
I _{CES}	Collector Cut-Off Current	V _{CE} =V _{CES} , V _{GE} =0V	-	-	1	mA
I _{GES}	G-E Leakage Current	V _{GE} =V _{GES} , V _{CE} =0V	-	-	+/-250	nA
On Characteristics						
V _{GE(th)}	G-E Threshold Voltage	I _C =25mA, V _{CE} =V _{GE}	4.0	5.5	7.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C =25A, V _{GE} =15V T _C =25°C	-	2	2.5	V
		I _C =25A, V _{GE} =15V T _C =125°C	-	2.15	-	V
Dynamic Characteristics						
C _{ies}	Input Capacitance	V _{CE} =30V, V _{GE} =0V, f=1MHz	-	3700	-	pF
C _{oes}	Output Capacitance		-	130	-	pF
C _{res}	Reverse Transfer Capacitance		-	80	-	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{CC} =600V, I _C =25A, R _G =10Ω, V _{GE} =15V, Inductive Load, T _C =25°C	-	50	-	ns
t _r	Rise Time		-	60	90	ns
t _{d(off)}	Turn-Off Delay Time		-	190	-	ns
t _f	Fall Time		-	100	180	ns
E _{on}	Turn-On Switching Loss		-	4.1	6.2	mJ
E _{off}	Turn-Off Switching Loss		-	0.96	1.5	mJ
E _{ts}	Total Switching Loss		-	5.06	7.7	mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} =600V, I _C =25A, R _G =10Ω, V _{GE} =15V, Inductive Load, T _C =125°C	-	50	-	ns
t _r	Rise Time		-	60	-	ns
t _{d(off)}	Turn-Off Delay Time		-	200	-	ns
t _f	Fall Time		-	154	-	ns
E _{on}	Turn-On Switching Loss		-	4.3	6.9	mJ
E _{off}	Turn-Off Switching Loss		-	1.5	2.4	mJ
E _{ts}	Total Switching Loss		-	5.8	9.3	mJ
Q _g	Total Gate Charge	V _{CC} =600V, I _C =25A, V _{GE} =15V	-	200	300	nC
Q _{ge}	Gate to Emitter Charge		-	15	23	nC
Q _{gc}	Gate to Collector Charge		-	100	150	nC

Electrical Characteristics of Diode $T_C=25^{\circ}\text{C}$

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units	
V _{FM}	Diode Forward Voltage	I _F =25A	T _C =25°C	-	2.0	3.0	V	
			T _C =125°C	-	2.1		V	
t _{rr}	Diode Reverse Recovery Time	I _F =25A, dI/dt=200A/us	T _C =25°C	-	235	350	ns	
			T _C =125°C	-	300		ns	
I _{rr}	Diode Peak Reverse Recovery Current		T _C =25°C	-	27	40	A	
			T _C =125°C	-	31		A	
Q _{rr}	Diode Reverse Recovery Charge		T _C =25°C	-	3130	4700	uC	
			T _C =125°C	-	4650		uC	

Typical Performance Characteristics

Figure 1. Typical Output Characteristics

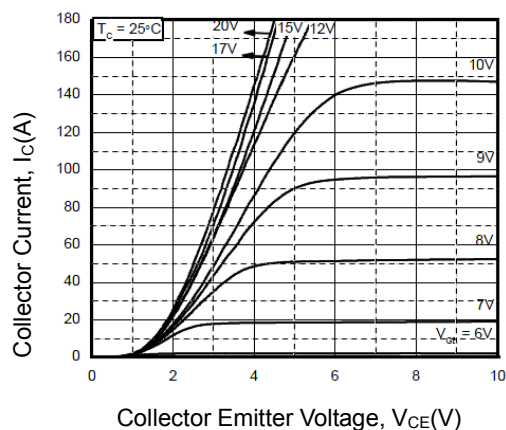


Figure 2. Typical Saturation Voltage Characteristics

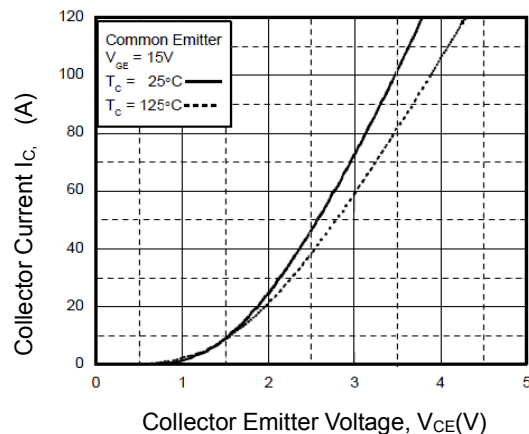


Figure 3. Saturation Voltage vs. Case Temperature at Variant Current Level

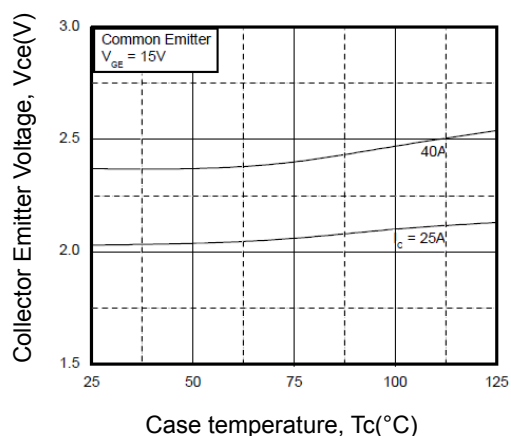


Figure 4. Saturation Voltage vs. V_GE

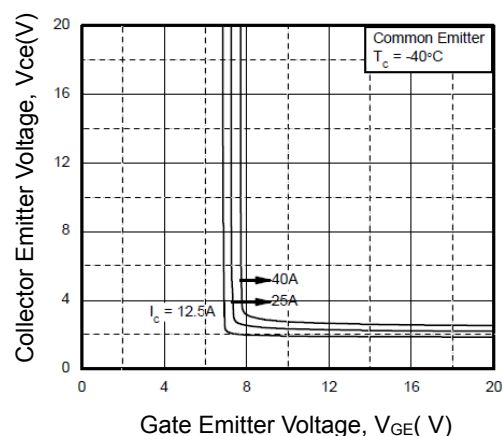


Figure 5. Saturation Voltage vs. V_GE

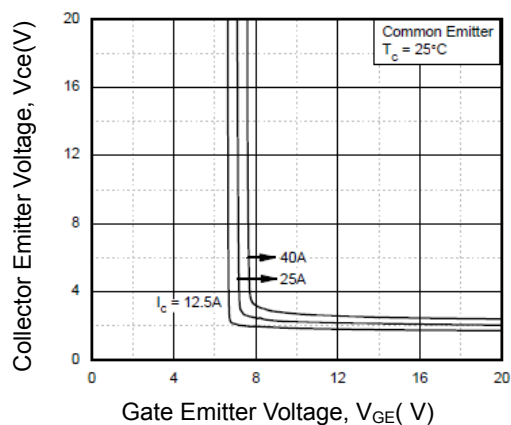
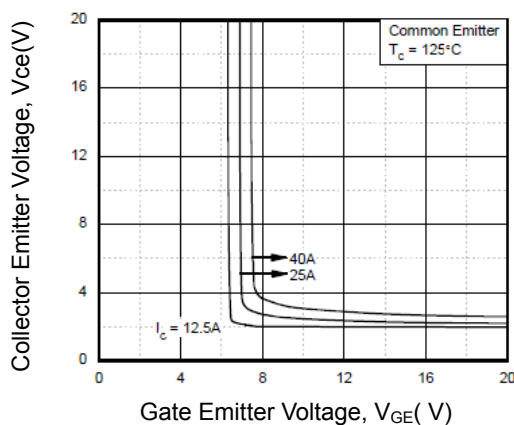


Figure 6. Saturation Voltage vs. V_GE



Typical Performance Characteristics (Continued)

Figure 7. Capacitance Characteristics

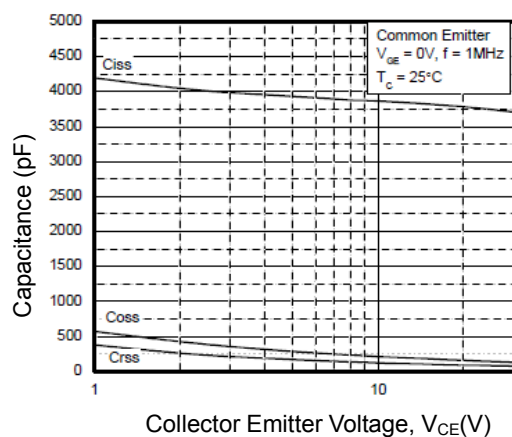


Figure 8. Turn-on Characteristics vs. Gate Resistance

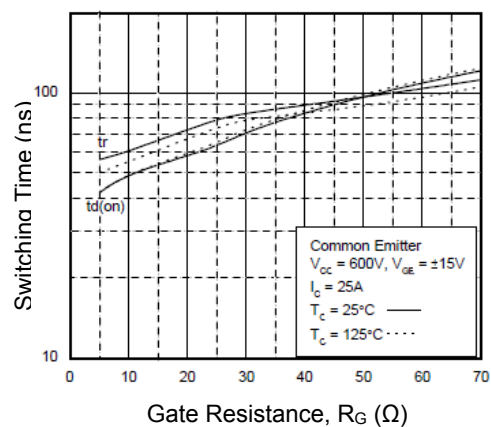


Figure 9. Turn-off Characteristics vs. Gate Resistance

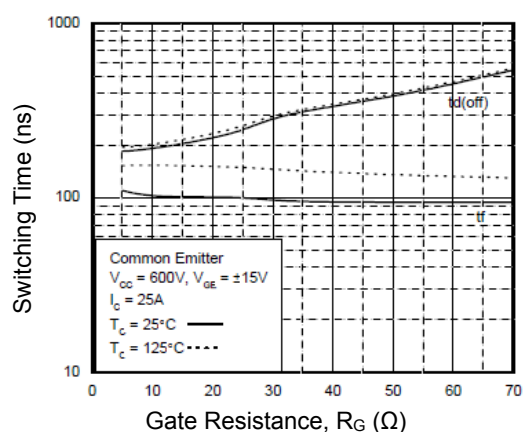


Figure 10. Switching Loss vs. Gate Resistance

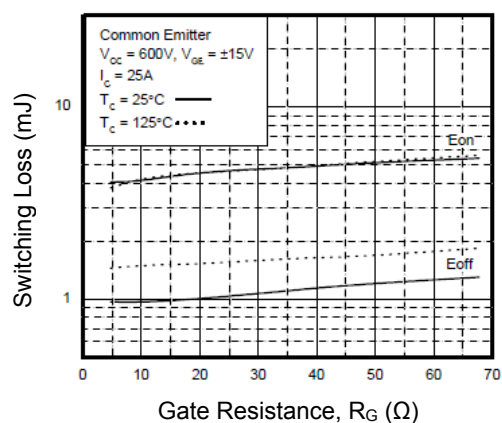


Figure 11. Turn-on Characteristics vs. Collector Current

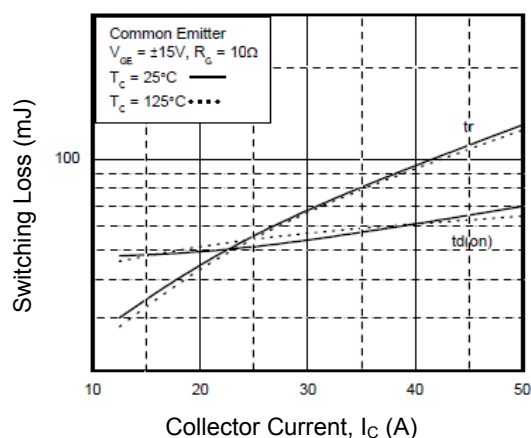
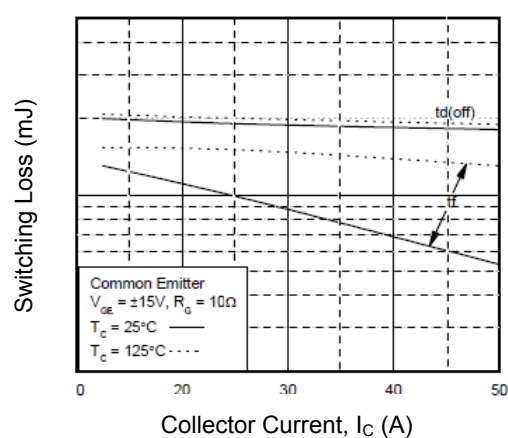


Figure 12. Turn-Off Characteristics vs. Collector Current



Typical Performance Characteristics (Continued)

Figure 13. Switching Loss vs. Collector Current

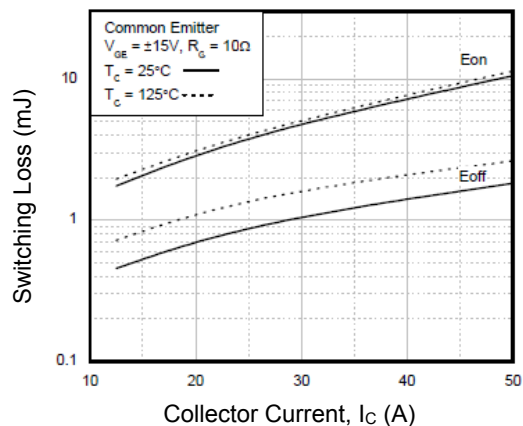


Figure 14. Gate Charge Characteristics

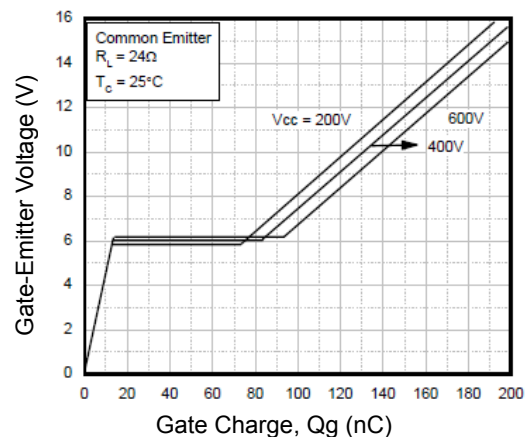


Figure 15. SOA Characteristics

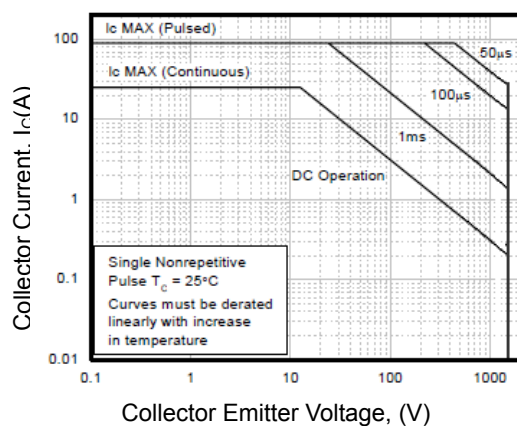


Figure 16. Turn-Off SOA

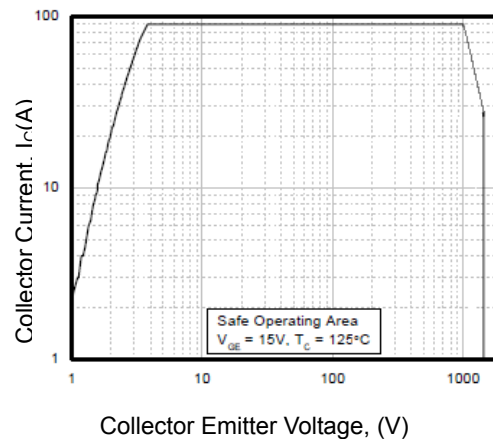
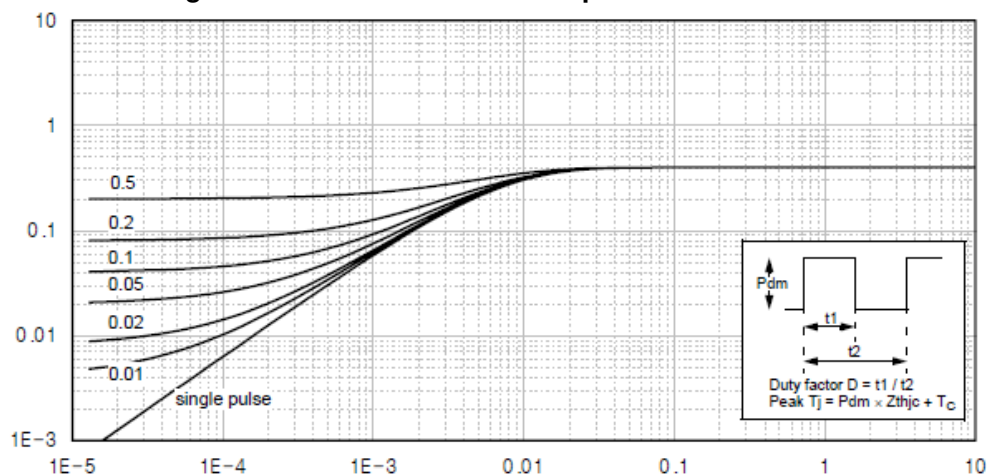
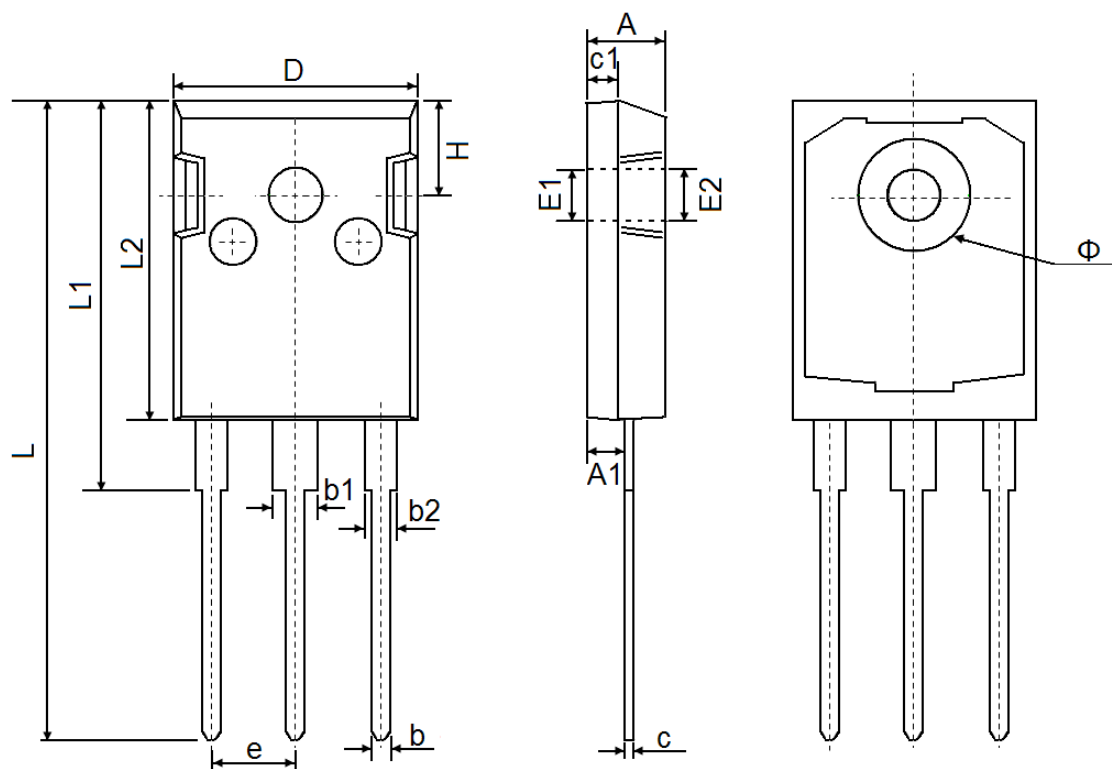


Figure 17. Transient Thermal Impedance of IGBT



TO-247 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.850	5.150	0.191	0.200
A1	2.200	2.600	0.087	0.102
b	1.000	1.400	0.039	0.055
b1	2.800	3.200	0.110	0.126
b2	1.800	2.200	0.071	0.087
c	0.500	0.700	0.020	0.028
c1	1.900	2.100	0.075	0.083
D	15.450	15.750	0.608	0.620
E1	3.500 REF		0.138 REF	
E2	3.600 REF		0.142 REF	
L	40.900	41.300	1.610	1.626
L1	24.800	25.100	0.976	0.988
L2	20.300	20.600	0.799	0.811
Φ	7.100	7.300	0.280	0.287
e	5.450 TYP		0.215 TYP	
H	5.980 REF		0.235 REF	